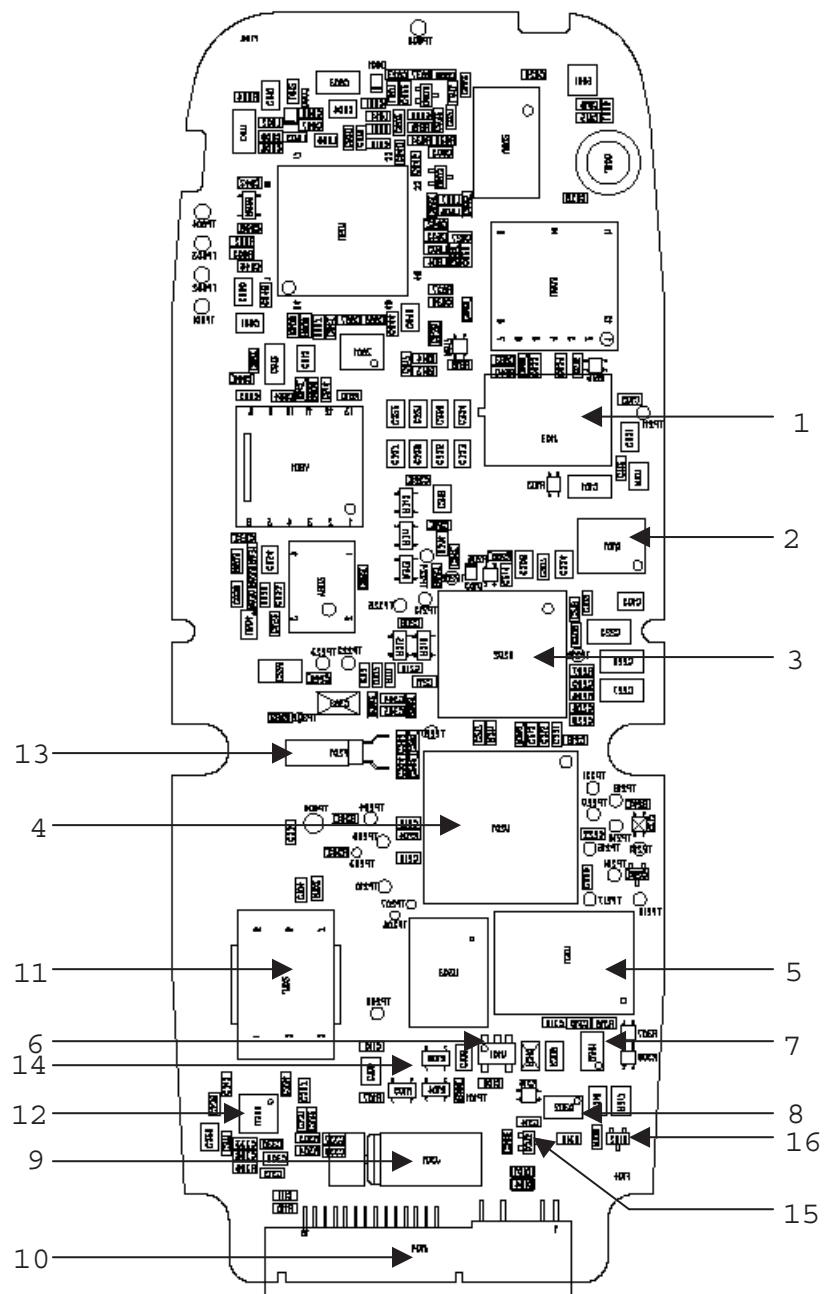


## **5. TEST POINT DATA**

### **Component Side (1-1)**

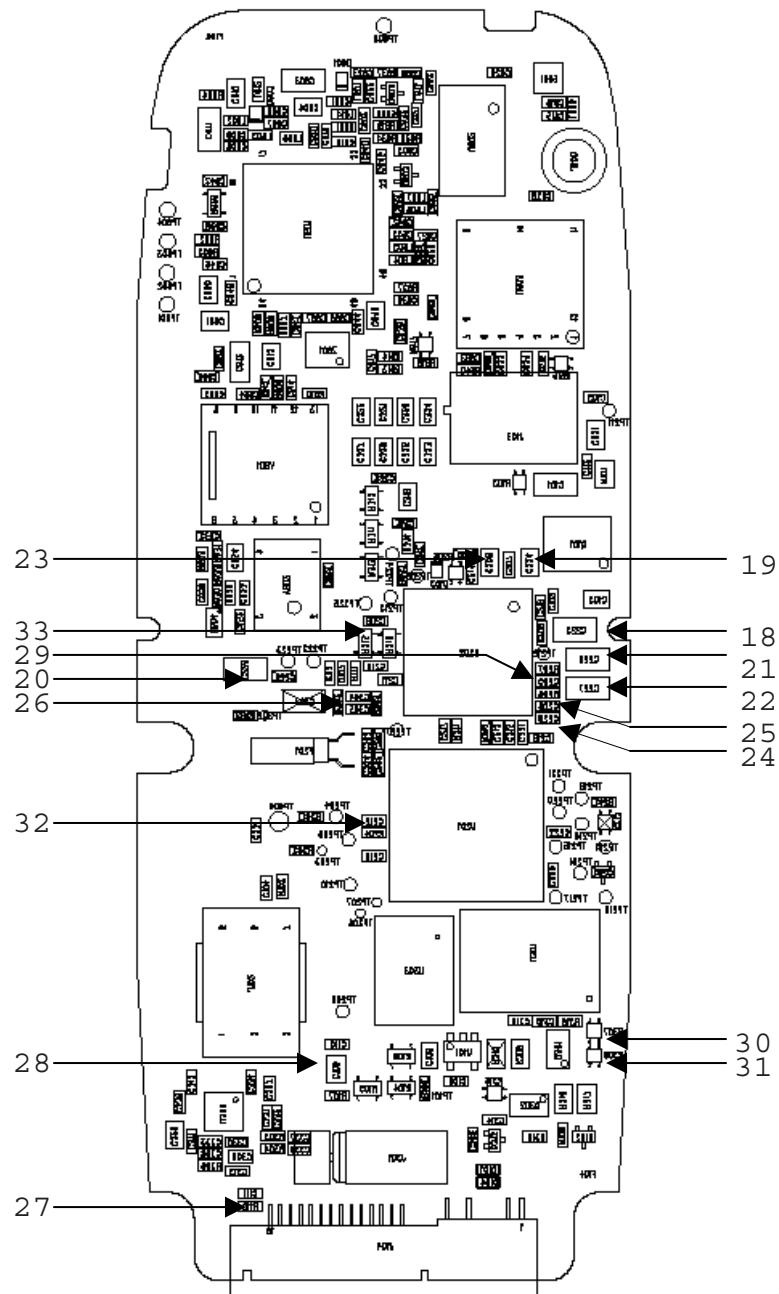


## 5. TEST POINT DATA

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|    | <b>Location</b>      | <b>Component Side (1-1)</b>   |
|----|----------------------|---|
| 1  | J103                 | Battery connector : For damage or cold soldering cause power on failure   |
| 2  | Q101                 | P-channel MOSFET with schottky diode : For damage or cold soldering cause charger function failure  |
| 3  | U202                 | Nausica_CS : analog baseband chipset (ABB)  |
| 4  | U201                 | Hercrom20 : digital baseband chipset (DBB)  |
| 5  | U301                 | 16Mbit flash ROM : For damage or cold soldering cause power on failure  |
| 6  | U101                 | 3V, 200mA LDO regulator : For damage or cold soldering cause accessory power failure.   |
| 7  | Q301                 | Isolated dual transistors : For damage or cold soldering Q301A cause vibration motor Failure, Q301B cause keypad back-light failure         |
| 8  | Q302                 | Isolated dual transistors : For damage or cold soldering Q302A cause pre-charger indication failure, Q302B cause the LCD back-light failure |
| 9  | J301                 | Vibration motor : For damage or bad connection cause vibrator failure.  |
| 10 | J104                 | System connector : For damage or cold soldering cause headset failure, trace/debug /SW download failure                                     |
| 11 | J102                 | SIM connector : For damage or bad connection cause SIM card failure.  |
| 12 | U302                 | Audio amplifier : For damage cause speaker function failure.  |
| 13 | Y201                 | 32.768kHz crystal : For damage cause RTC function failure.  |
| 14 | R104<br>R105<br>R109 | 8P4R resistor network : For damage or cold soldering cause trace/debug /SW download failure   |
| 15 | D313                 | Switching diode array : For damage or cold soldering cause the surge noise by Vibrator  |
| 16 | D102                 | Switching diode array : For damage or cold soldering cause the flash fast program function failure  |

Component Side (1-2)

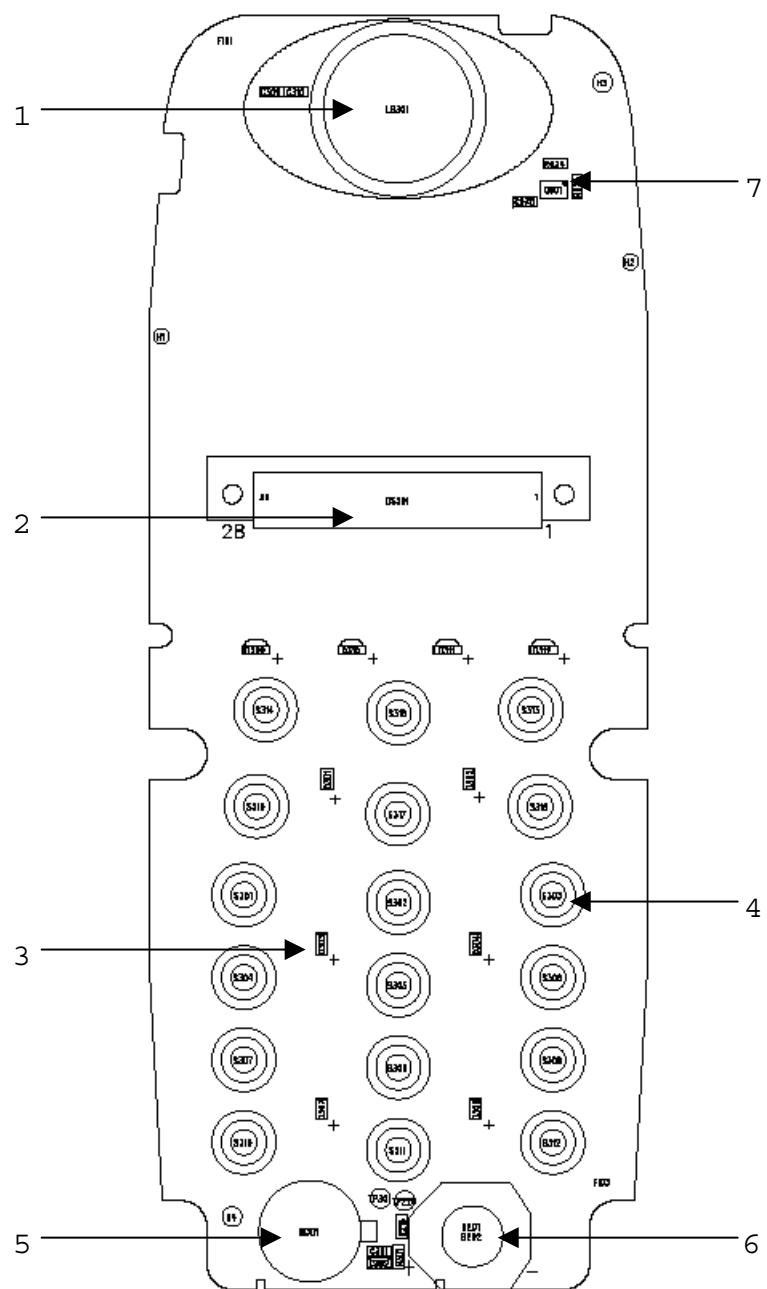


## 5. TEST POINT DATA

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|    | <b>Location</b>              | <b>Component Side (1-2)</b>   |
|----|------------------------------|---|
| 18 | C223                         | VR2B regulator (2.85V) : For damage or cold soldering cause power supply for DBB & ABB peripheral failure.  |
| 19 | C224                         | VR1B regulator (2V) : For damage or cold soldering cause power supply for ABB internal logic failure        |
| 20 | C225                         | VR3 regulator (2.85V) : For damage or cold soldering cause power supply for ABB analog circuits failure     |
| 21 | C226                         | VR2 regulator (2.9V) : For damage or cold soldering cause power supply for Memory device failure.           |
| 22 | C227                         | VR1 regulator (1.8V) : For damage or cold soldering cause power supply for DBB Core & RTC failure           |
| 23 | C207<br>C208                 | SIM regulator (3V/5V) : For damage or cold soldering cause power supply for SIM Interface failure           |
| 24 | C206                         | VREF output (1.2V) : For damage or cold soldering cause power supply for power on failure                   |
| 25 | R208                         | IBIAS output : For damage or cold soldering cause power supply for Power on failure                         |
| 26 | R301<br>C304<br>C305         | Microphone Input : For damage or cold soldering cause microphone failure                                    |
| 27 | R110<br>C107                 | Ext. audio Input : For damage or cold soldering cause external audio input failure                          |
| 28 | C106<br>R107                 | Ext. audio output : For damage or cold soldering cause external audio output failure                        |
| 29 | R207<br>C205                 | ABB local Osc. generator : For damage or cold soldering cause ABB local Osc. failure                        |
| 30 | R307A<br>R308A               | Vibrator control : For damage or cold soldering cause vibrator failure                                      |
| 31 | R307A<br>R308A               | Back-light control : For damage or cold soldering cause all back-light LED failure                          |
| 32 | R204                         | SIM card power control : For damage or cold soldering cause SIM card power control failure.                 |
| 33 | R210<br>R215<br>C209<br>C210 | Uplink & downlink I/Q Filtering : For damage or cold soldering cause uplink or downlink I/Q signal failure. |

**Keypad Side (2-1)**



## 5. TEST POINT DATA

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|   | <b>Location</b> | <b>Keypad Side (2-1)</b>   |
|---|-----------------|--|
| 1 | LS301           | Speaker : For bad connection cause speaker failure                                     |
| 2 | DS301           | LCM Connector : For damage or cold soldering cause LCD Display failure                 |
| 3 | D301~D312       | Back-Light LED : For damage or cold soldering cause back-light LED failure             |
| 4 | S301~S317       | Keypad Switches : For damage or short circuit cause keypad function failure            |
| 5 | M301            | Microphone holder : For damage or cold soldering cause microphone failure              |
| 6 | B201            | Batter holder : For damage or cold soldering cause RTC function failure                |
| 7 | Q601            | T/R Switch transistor : For damage or cold soldering cause T/R Switch function failure |